

ISL705xRH/EH and ISL706xRH/EH

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Single-Event Effects (SEE) Testing of the ISL705xRH/EH and ISL706xRH/EH Radiation Hardened Supervisory Circuits

Introduction

The intense heavy ion environment encountered in space applications can cause a variety of transient and destructive effects in analog circuits, including single-event latch-up (SEL), single-event transient (SET) and single-event breakdown (SEB). These effects can lead to system-level failures including disruption and permanent damage. For predictable, reliable system operation, these components have to be formally designed and fabricated for SEE hardness, followed by detailed SEE testing to validate the design. This report discusses the results of SEE testing of Intersil's ISL705xRH/EH and ISL706xRH/EH family of microprocessor supervisory circuits.

Reference Documents

- [ISL705ARH](#), [ISL705BRH](#), [ISL705CRH](#), [ISL706ARH](#), [ISL706BRH](#), [ISL706CRH](#) Data Sheet

Product Description

The Intersil ISL705x and ISL706x are microprocessor supervisory circuits that monitor power supply voltage and battery functions in microprocessor systems. The ISL705x series is ideal for 5V systems while the ISL706x series is geared toward 3.3V systems. Both are offered in 3 reset options, the A versions have an active low reset option; the B versions have active high reset option and the C version offers an active low open drain reset. All circuits provide the following functions:

1. A reset output during power-up, power-down, and brownout conditions.
2. A precision 4.65V (ISL705x)/3.08V (ISL706x) power supply voltage monitor.
3. A watchdog timer that switches to the LOW state if the timer input has not been toggled within 1.0 second (min).
4. A 1.25V (ISL705x)/0.6V (ISL706x) threshold detector to monitor an auxiliary power supply voltage.
5. An active-low manual-reset input.

The supervisory circuits are fabricated on a 0.6µm BiCMOS junction isolated process optimized for power management applications. This integrated circuit was hardened by design to achieve a Total Ionizing Dose (TID) rating of at least 100krads(Si) at the standard 50 to 300rad(Si)/s high dose rate as well as the standard <10mrad(Si)/s low dose rate. Well known TID hardening methods were employed such as closed geometry NMOS devices to reduce leakage and optimized bias levels for bipolar devices to compensate for gain reduction. This family of supervisory circuits were also hardened by design to a Linear Energy Transfer (LET) of 86.4MeV/mg/cm² by employing various SEE hardening techniques such as proper device sizing, filtering and special layout constraints.

SEE Summary

- No SEL/SEB at LET 86.4 MeV • cm²/mg with V_{DD} = 6.5V
- No SET events indicating false RESEts with V_{DD} ≥ V_{RST} max
- No SET events on $\overline{\text{PFO}}$ when PFI Input > V_{PFI} max

SEE Test Objective

The objectives of SEE testing of the ISL705xRH/EH and ISL706xRH/EH were to evaluate its susceptibility to single-event latch-up and single-event burnout and characterize its SET behavior.

SEE Test Facility

Testing was performed at the Texas A&M University (TAMU) Cyclotron Institute heavy ion facility. This facility is coupled to a K500 super-conducting cyclotron, which is capable of generating a wide range of test particles with the various energy, flux and fluence levels needed for advanced radiation testing.

SEE Test Procedure

The part was tested for single-event effects using Au ions (LET = 86.4MeV/mg/cm²). A schematic of the SEE test circuit is shown in [Figure 1](#).

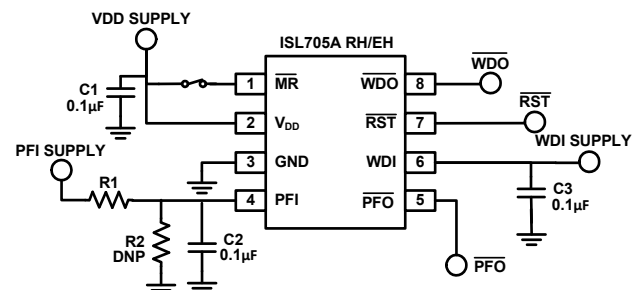


FIGURE 1. ISL705A, ISL706A SEE TEST SCHEMATIC

The device under test was mounted in the beam line and irradiated with heavy ions of the appropriate species. The parts were assembled in dual in-line packages with the metal lid removed for beam exposure. The beam was directed on to the exposed die and the beam flux, beam fluence and errors in the device outputs were measured.

The tests were controlled remotely from the control room. All input power was supplied from portable power supplies connected via cable to the device under test (DUT). The supply currents were monitored along with the device outputs. All currents were measured with digital ammeters, while all the output waveforms were monitored on a digital oscilloscope for ease of identifying the different types of SEE which the part displayed. Events were captured by triggering on changes in the output in time, such as changes in duty cycle or phase shifts.

Single-Event Latch-up and Burnout Results

Unlike the other Intersil space products, these supervisory circuits are built in a junction-isolated process in which latch-up is at least a theoretical possibility; other Intersil Space Products use various dielectrically isolated (DI) processes in which latch-up is not possible.

Accordingly, the first testing sequence looked at destructive effects. No burnout or latch-up was observed using Au ions ($LET = 86.4\text{MeV/mg/cm}^2$) at 0° incidence from perpendicular. Testing was performed on four parts at $+125^\circ\text{C}$ (case temperature) and up to the maximum voltage ($V_{DD} = 6.5\text{V}$). The first part (part ID 5) commenced testing with $V_{DD} = 5.5\text{V}$ and on subsequent tests V_{DD} voltage was increased to 6V, 6.2V and 6.5V. All other parts were tested with a V_{DD} of 6.2V and 6.5V. All test runs were run to a fluence of $1 \times 10^7/\text{cm}^2$. The WDI and PFI inputs were toggled from 0V to V_{DD} at 1kHz. The \overline{MR} input was tied to V_{DD} during SEL and SEB testing. Functionality of all outputs was verified after exposure. I_{DD} was recorded pre and post exposure, under continuous power; results are shown in [Table 1](#). No destructive effects of any kind were encountered in these tests. It is also important to note that SEL/SEB testing was done only on the ISL705A. From a design perspective the ISL705A and the ISL706A are exactly the same; however the ISL706 series of supervisors were internally biased to different voltage levels to achieve the 3.3V specifications. The voltage thresholds, even though they are different values, are produced the same way and trimmed through a resistor ladder network. They are built in the same process and functionality is equivalent. Therefore, all ISL705A SEL/SEB results are applicable to the ISL706A.

TABLE 1. I_{DD} PRE AND POST SEL/SEB TESTING

PART ID	V_{DD} (V)	TEMPERATURE ($^\circ\text{C}$)	PRE EXPOSURE	POST EXPOSURE
			I_{DD} (μA)	I_{DD} (μA)
5	5.5	+125	509	509
5	6.0	+125	536	535
5	6.2	+125	546	545
5	6.5	+125	563	562
6	6.2	+125	551	551
6	6.5	+125	565	565
7	6.2	+125	555	555
7	6.5	+125	573	572
8	6.2	+125	552	552
8	6.5	+125	570	570

Single-Event Transient Testing

Transient on the outputs (\overline{RST} , \overline{WDO} , \overline{PFO}) were counted for various supply voltages for both the ISL705A (RH/EH) and the ISL706A (RH/EH). Single-event transients (SET) are defined as a digital state change in the output based on crossing the V_{OH} threshold for a low-high-low (LHL) transient and V_{OL} threshold for a high-low-high (HLH) transient. Testing was performed using the same test configuration as described previously for SEB/SEL testing. Au ions with an LET of 86.4MeV/mg/cm^2 were used during testing and all tests were performed at $+25^\circ\text{C}$. All tests were performed on 4 parts and the results are summarized in the following sections.

ISL705A Reset Results

The first test set V_{DD} at 4.5V and \overline{MR} at V_{DD} ; under these conditions, Reset should be low (as V_{DD} is below the nominal V_{DD} reset threshold of 4.65V). Using a fluence of $2 \times 10^6/\text{cm}^2$, no transients were observed during this test on any of the 4 parts. This was an encouraging result, as it means that during a low V_{DD} condition there would be no false signals sent from Reset indicating that V_{DD} is within tolerances. The second test set V_{DD} at 4.75V and \overline{MR} at V_{DD} , hence Reset should be high (as V_{DD} is above the nominal V_{DD} reset threshold of 4.65V). Each part was run to a fluence of $2 \times 10^6/\text{cm}^2$ each and no HLH transients were observed on Reset. V_{DD} was then raised to 5V, a more typical application, and still no transients were observed. Lastly, V_{DD} was then raised to 5.5V and no transients were observed. In all cases where V_{DD} was above the threshold voltage, no false signals were sent from Reset indicating that V_{DD} was below the threshold voltage, when in reality, it wasn't.

When Reset was driven low by setting $\overline{MR} = 0\text{V}$ (V_{DD} was returned to 5V) there were no transients with Au ions. The test was redone with V_{DD} at 5.5V and again no transients were seen on the Reset output. Observing no transients was not a surprising result, as the SET would have to last longer than the 200ms reset timer period to get a false transition to a "1" level.

In summary, the part has no Reset LHL transients when V_{DD} is less than 4.75V or is held low by \overline{MR} input being held low. This means the system will not have any false Reset signal telling it that V_{DD} is within tolerance when it isn't, or that it can operate while the \overline{MR} (manual reset) is being applied. When $V_{DD} > 4.75\text{V}$ and $\overline{MR} = "1"$ there are no HLH transients that would cause the system to go through an unnecessary reset cycle.

ISL705A \overline{WDO} Results

\overline{WDO} has many modes of operation, depending on whether V_{DD} is below 4.5V or above 4.75V, the state of \overline{MR} and whether WDI is toggling, DC low, DC high or floating. [Table 2](#) shows these results. With the largest cross section observed in any \overline{WDO} test being $3.9 \times 10^{-6}\text{cm}^2$, natural space transients will be hundreds to thousands of years apart. When used as a low line indicator, ISL706A (\overline{WDO} left floating) transients were only seen when V_{DD} was below the reset threshold. Transients observed were in the range of $2\mu\text{s}$ to $20\mu\text{s}$ (see [Figures 2](#) and [3](#)). The only other time transients occurred was when WDI was toggling, but again, V_{DD} was below the reset threshold and the cross section is $2.5 \times 10^{-6}\text{cm}^2$ (see [Figure 4](#)).

Additional testing at lower LET levels was done on the $\overline{WD0}$ output in the conditions that experienced SETs, e.g., $V_{DD} = 4.4V$ with WDI toggling and $V_{DD} = 4.5V$ with WDI floating. [Table 3](#) shows the cross section versus the different LET levels tested.

Note that the fluence was increased as the LET levels were lowered and that the SET events only occurred when V_{DD} is equal or slightly below the RESET threshold voltage. A typical application would not hold the supply voltage in this range.

TABLE 2. $\overline{WD0}$ TRANSIENTS vs MODE OF OPERATION ($\overline{MR} = V_{DD}$ unless noted otherwise)

LET (MeV/mg/cm ²)	WDI STATE	V _{DD} (V)	EXPECTED $\overline{WD0}$ STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	Toggle	4.4	0	20	N/A	8 x 10 ⁶	2.5 x 10 ⁻⁶
	Toggle $\overline{MR} = 0$	5	1	N/A	0	8 x 10 ⁶	
	Float	4.75	1	N/A	0	8 x 10 ⁶	
	Float	4.5	0	31	N/A	8 x 10 ⁶	3.9 x 10 ⁻⁶
	5V	5	0	0	N/A	8 x 10 ⁶	
	0V	5	0	0	0	N/A	8 x 10 ⁶

TABLE 3. $\overline{WD0}$ TRANSIENTS vs LET ($\overline{MR} = V_{DD}$ unless noted otherwise)

LET (MeV/mg/cm ²)	WDI STATE	V _{DD} (V)	EXPECTED $\overline{WD0}$ STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	Toggle	4.4	0	20	N/A	8 x 10 ⁶	2.5 x 10 ⁻⁶
43	Toggle	4.4	0	4	N/A	1.6 x 10 ⁷	2.5 x 10 ⁻⁷
28	Toggle	4.4	0	0	N/A	4 x 10 ⁷	
8.5	Toggle	4.4	0	0	N/A	8 x 10 ⁷	
86.4	Float	4.5	0	31	N/A	8 x 10 ⁶	3.9 x 10 ⁻⁶
43	Float	4.5	0	37	N/A	1.6 x 10 ⁷	2.3 x 10 ⁻⁶
28	Float	4.5	0	15	N/A	4 x 10 ⁷	3.8 x 10 ⁻⁷
8.5	Float	4.5	0	0	N/A	8 x 10 ⁷	



FIGURE 2. TRANSIENTS ON \overline{WDO} , $V_{DD} = \overline{MR} = 4.5V$, $PFI = 1.15V$, WDI IS FLOATING

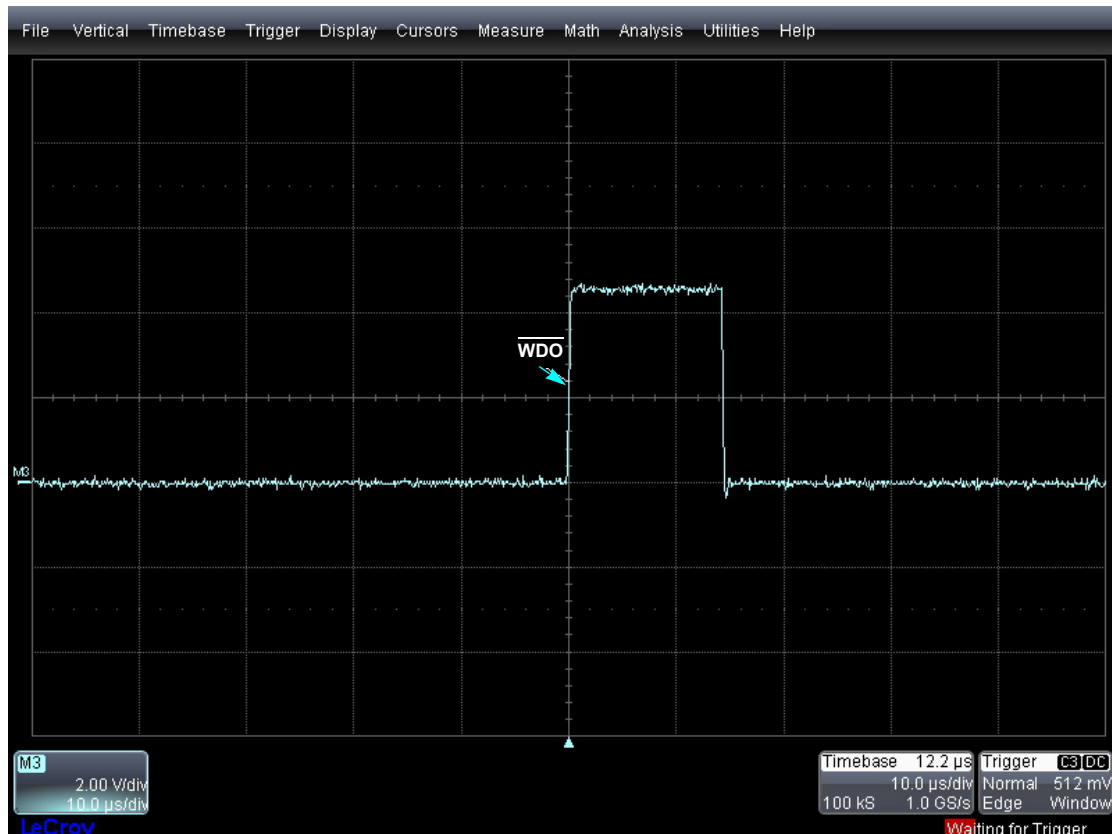


FIGURE 3. SAME \overline{WDO} TRANSIENT AS [Figure 2](#) WITH 10 μ s PER DIVISION TIME SCALE



FIGURE 4. TRANSIENT ON \overline{WDO} ($V_{DD} = \overline{MR} = 4.4V$, $PFI = 1.15V$, WDI IS TOGGLING 0 TO V_{DD} AT 1kHz)

ISL705A \overline{PFO} Results

The PFI/\overline{PFO} function is that of a comparator with the negative input tied to an on-chip 1.25V voltage reference. The PFI input is tied to the positive comparator input and \overline{PFO} is the comparator output. The specifications allow a $\pm 50mV$ offset over temperature and radiation. Hence, input voltages below 1.2V set \overline{PFO} low and voltages above 1.3V set \overline{PFO} high. Table 4 lists \overline{PFO} transients as a function of PFI input voltage for Au ions. Transients were seen when driving PFI to the minimum specs of 1.2V. By increasing the comparator overdrive, the transient cross-section can be reduced or eliminated. Even at minimum overdrive conditions (input 1.2V), the transient cross section is so small that the occurrence will be hundreds to thousands of years apart. For further reductions, an off-chip low pass filter could be used. Figure 5 shows scope traces for \overline{PFO} transients with PFI at 1.2V. Note the LHL transient is 4μs to 6μs long, adding an external low-pass filter would reduce the glitch. This would add delay in the system that the designer would need to evaluate.

Additional testing at lower LET levels was done on the \overline{PFO} output in the conditions that experienced SETs, e.g., $V_{DD} = 4.75V$ with $PFI = 1.2V$. Table 5 shows the cross section versus the different LET levels tested. Note that the fluence was increased as the LET levels were lowered.

ISL705A Summary

The key objective of burnout or latch-up hardness to an LET of 86.4MeV/mg/cm² has been demonstrated. No Reset LHL SEE transients at an LET of 86.4MeV/mg/cm² have been demonstrated once V_{DD} is above the maximum threshold voltage. Other functions have demonstrated cross sections so small as to not occur for hundreds to thousands of years. These characteristics must be evaluated by the system designer for the particular environment of interest and the usage of the available features of the ISL705A.

TABLE 4. \overline{PFO} TRANSIENTS vs PFI INPUT VOLTAGE ($\overline{MR} = V_{DD}$ unless noted otherwise)

LET (MeV/mg/cm ²)	PFI VOLTAGE (V)	V_{DD} (V)	EXPECTED \overline{PFO} STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	1.15	4.5	0	0	N/A	8×10^6	
	1.2	4.75	0	25	N/A	8×10^6	3.1×10^{-6}
	1.3	5	1	N/A	0	8×10^6	
	1.	5.5	1	N/A	0	8×10^6	

TABLE 5. $\overline{\text{PFO}}$ TRANSIENTS vs LET for PFI = 1.2V ($\overline{\text{MR}} = V_{\text{DD}}$ unless noted otherwise)

LET (MeV/mg/cm ²)	PFI VOLTAGE (V)	V _{DD} (V)	EXPECTED $\overline{\text{PFO}}$ STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	1.2	4.75	0	25	N/A	8 x 10 ⁶	3.1 x 10 ⁻⁶
43	1.2	4.75	0	19	N/A	1.6 x 10 ⁷	1.2 x 10 ⁻⁶
28	1.2	4.75	0	5	N/A	4 x 10 ⁷	1.3 x 10 ⁻⁷
8.5	1.2	4.75	0	0	N/A	8 x 10 ⁷	

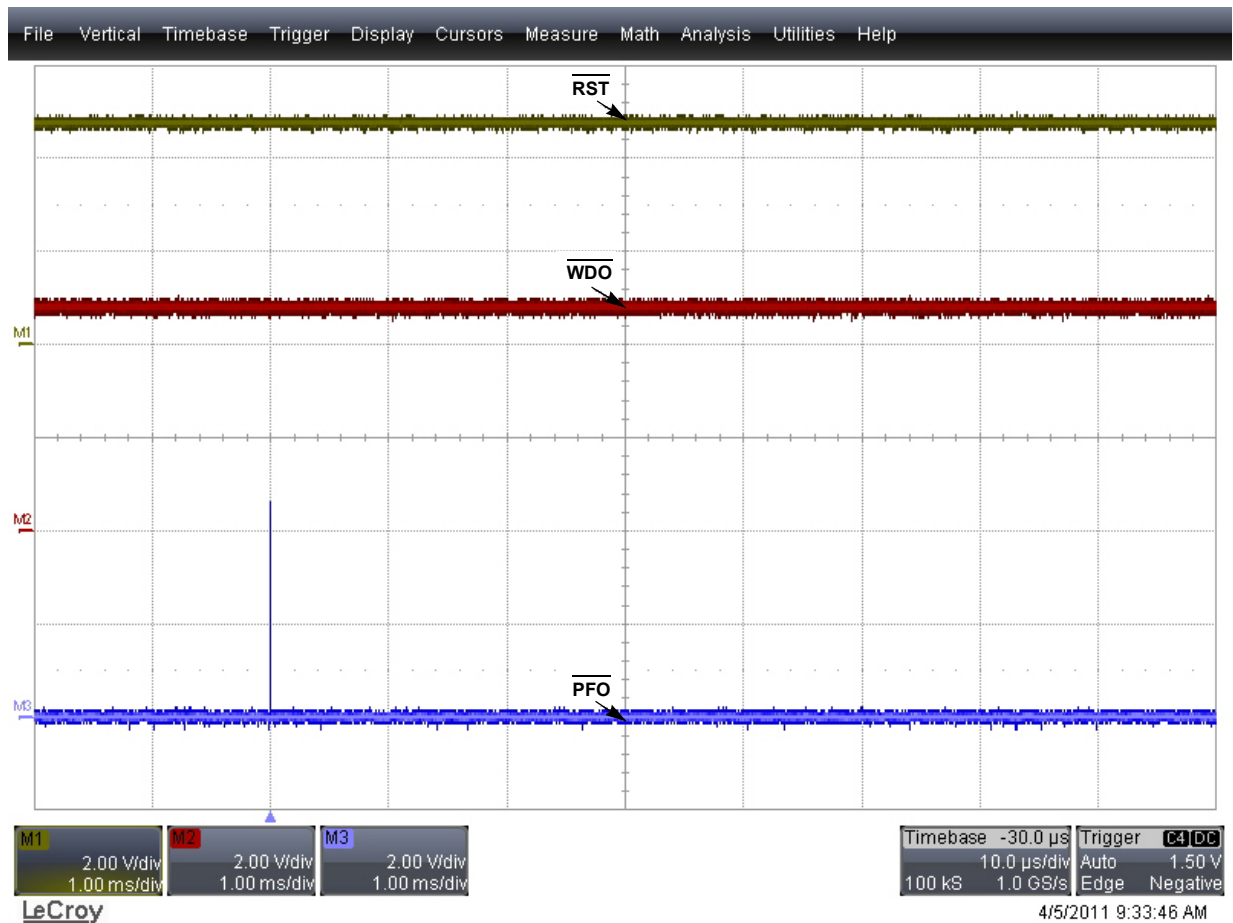


FIGURE 5. TRANSIENT ON $\overline{\text{PFO}}$ ($V_{\text{DD}} = \overline{\text{MR}} = 4.75\text{V}$, PFI = 1.2V, $\overline{\text{WDO}}$ IS FLOATING)

ISL706A Reset Results

The ISL706A is the same as the ISL705A with different bias levels for 3.3V operation. Similar results are expected, however, the tighter voltage thresholds and the lower bias levels might introduce more transients. The first test set V_{DD} at 3V and $\overline{\text{MR}}$ at V_{DD} ; under these conditions, Reset should be low (as V_{DD} is below the nominal V_{DD} reset threshold of 3.08V). Using a fluence of $2 \times 10^6/\text{cm}^2$, no transients or transients were observed during this test on any of the 4 parts. This was an encouraging result, which means that during a low V_{DD} condition, there would be no false signals sent from Reset indicating that V_{DD} is within tolerances.

The second test set V_{DD} at 3.15V and $\overline{\text{MR}}$ at V_{DD} , hence, Reset should be high (as V_{DD} is above the nominal V_{DD} reset threshold of 3.08V). Each part was run to a fluence of $2 \times 10^6/\text{cm}^2$ each

and no HLH transients were observed on Reset. V_{DD} was then raised to 3.3V, a more typical application, and still no transients were observed. Lastly, V_{DD} was then raised to 3.6V and no transients were observed. All cases where V_{DD} was above the threshold voltage, no false signals were sent from Reset indicating a low line condition.

When Reset was driven low by setting $\overline{\text{MR}} = 0\text{V}$ (V_{DD} was returned to 3.3V), there were no transients with Au ions. The test was redone with V_{DD} at 3.6V and again, no transients were seen on the Reset output. Observing no transients was not a surprising result, as the SET would have to last longer than the 200ms Reset timer period to get a false transition to a “1” level.

In summary, the part has no Reset LHL transients when V_{DD} is less than 3V or is held low by $\overline{\text{MR}}$ input being held low. This means the system will not have any false Reset signals telling it

that V_{DD} is within tolerance when isn't, or that it can operate while the \overline{MR} (manual reset) is being applied. When $V_{DD} > 3.15V$ and $\overline{MR} = "1"$, there are no HLH transients that would cause the system to go through an unnecessary reset cycle.

ISL706A \overline{WDO} Results

\overline{WDO} has many modes of operation, depending on whether V_{DD} is below 3.0V or above 3.15V, the state of \overline{MR} and whether WDI is toggling, DC low, DC high or floating. Table 6 shows these results. With the largest cross section observed in any \overline{WDO} test being $98 \times 10^{-6} \text{ cm}^2$, natural space transients will be hundreds to thousands of years apart. When used as a low line indicator (\overline{WDO} left floating) transients were only seen when V_{DD} was below the reset threshold. Transients observed were in the range

of $8\mu\text{s}$ to $24\mu\text{s}$ (see Figures 6 and 7). The only other time transients occurred was when WDI was toggling, thus again V_{DD} was below the reset threshold and the cross section is $2.1 \times 10^{-6} \text{ cm}^2$ (see Figures 8 and 9).

Additional testing at lower LET levels was done on the \overline{WDO} output in the conditions that experienced SETs, e.g., $V_{DD} = 2.9V$ with WDI toggling and $V_{DD} = 3.0V$ with WDI floating. Table 7 shows the cross section versus the different LET levels tested. Note that the fluence was increased as the LET levels were lowered. Once again the only time the device experience SETs when the supply voltage was equal to or slightly below the RESET threshold voltage. In a typical application, the supply voltage would be at 3.3V constantly.

TABLE 6. \overline{WDO} TRANSIENTS vs MODE OF OPERATION ($\overline{MR} = V_{DD}$ unless noted otherwise)

LET (MeV/mg/cm ²)	WDI STATE	V _{DD} (V)	EXPECTED \overline{WDO} STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	Toggle	2.9	0	17	N/A	8×10^6	2.1×10^{-6}
	Toggle $\overline{MR} = 0$	3.3	1	N/A	0	8×10^6	
	Float	3.15	1	N/A	0	8×10^6	
	Float	3	0	784	N/A	8×10^6	9.8×10^{-5}
	3.3V	3.3	0	0	N/A	8×10^6	
	0V	3.3	0	0	N/A	8×10^6	

TABLE 7. \overline{WDO} TRANSIENTS vs LET ($\overline{MR} = V_{DD}$ unless noted otherwise)

LET (MeV/mg/cm ²)	WDI STATE	V _{DD} (V)	EXPECTED \overline{WDO} STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	Toggle	2.9	0	17	N/A	8×10^6	2.1×10^{-6}
43	Toggle	2.9	0	1	N/A	1.6×10^7	6.3×10^{-8}
28	Toggle	2.9	0	0	N/A	4×10^7	
8.5	Toggle	2.9	0	0	N/A	8×10^7	
86.4	Float	3	0	784	N/A	8×10^6	9.8×10^{-5}
43	Float	3	0	1062	N/A	1.6×10^7	6.6×10^{-5}
28	Float	3	0	1909	N/A	4×10^7	4.8×10^{-5}
8.5	Float	3	0	58	N/A	8×10^7	7.3×10^{-7}

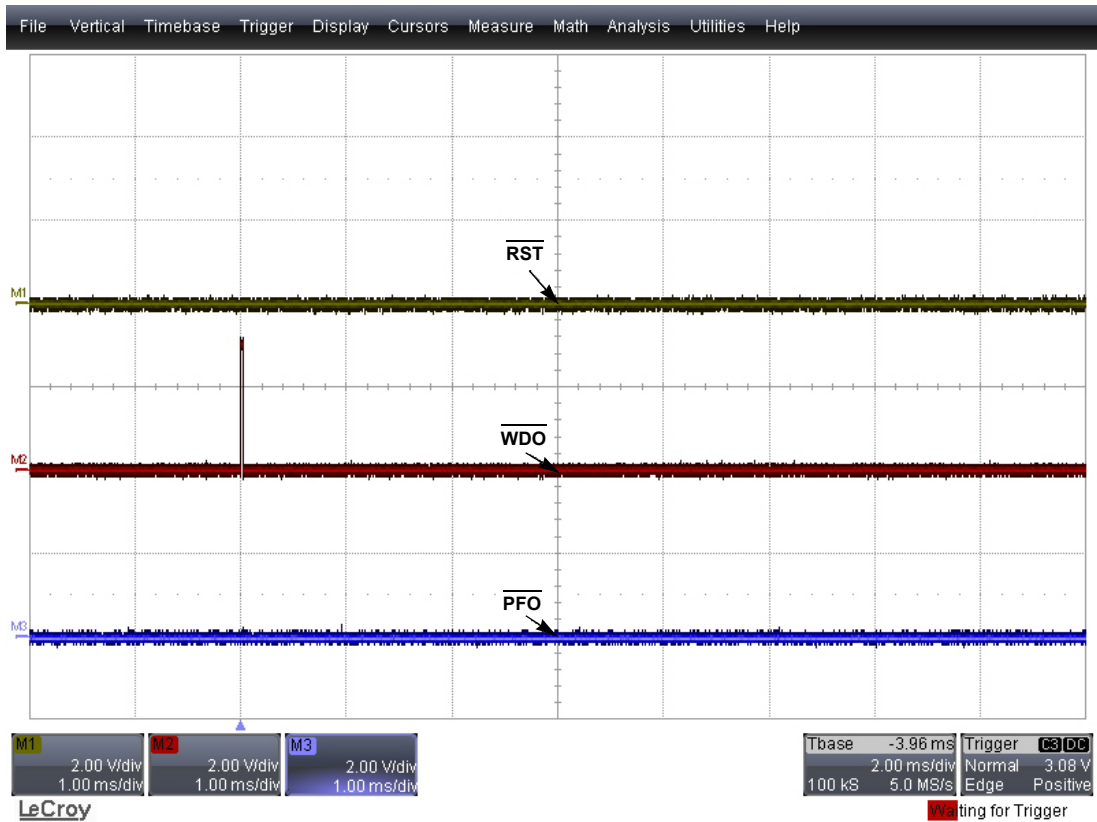


FIGURE 6. TRANSIENTS ON \overline{WDO} , $V_{DD} = \overline{MR} = 3.0V$, $PFI = 0.57V$, WDI IS FLOATING

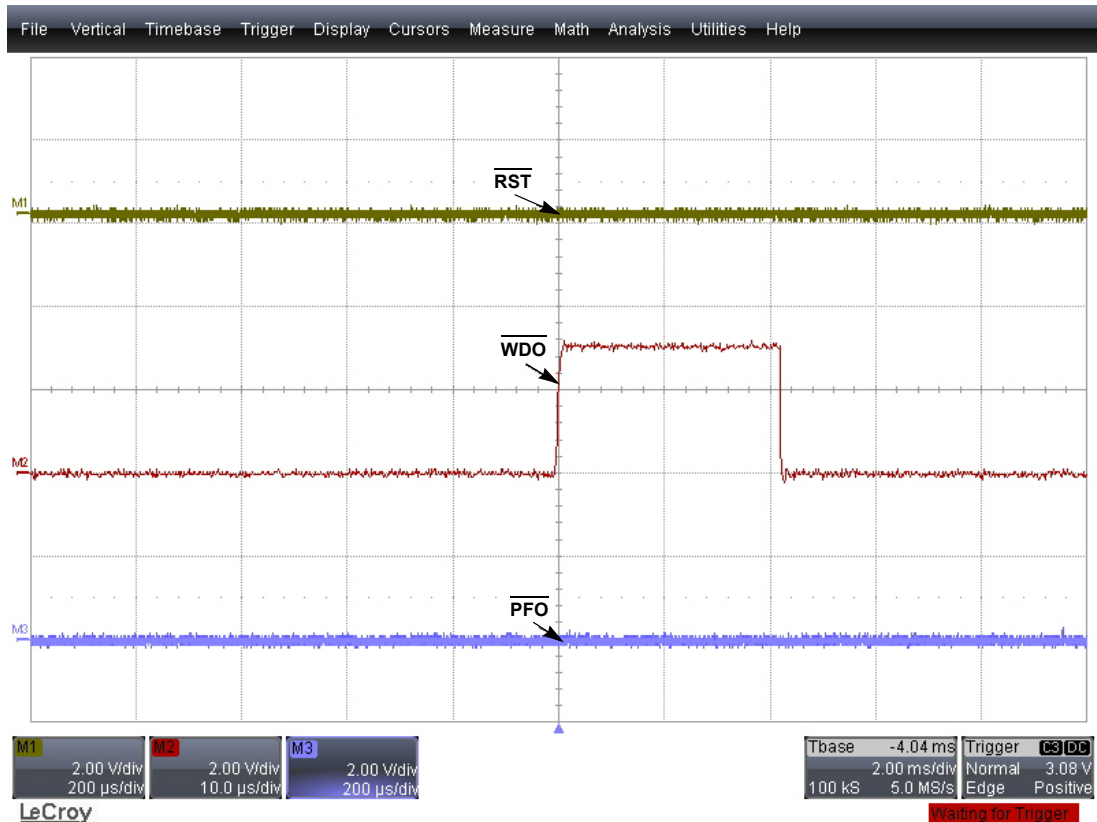


FIGURE 7. SAME \overline{WDO} TRANSIENT AS [Figure 6](#) WITH 10 μ s PER DIVISION TIME SCALE

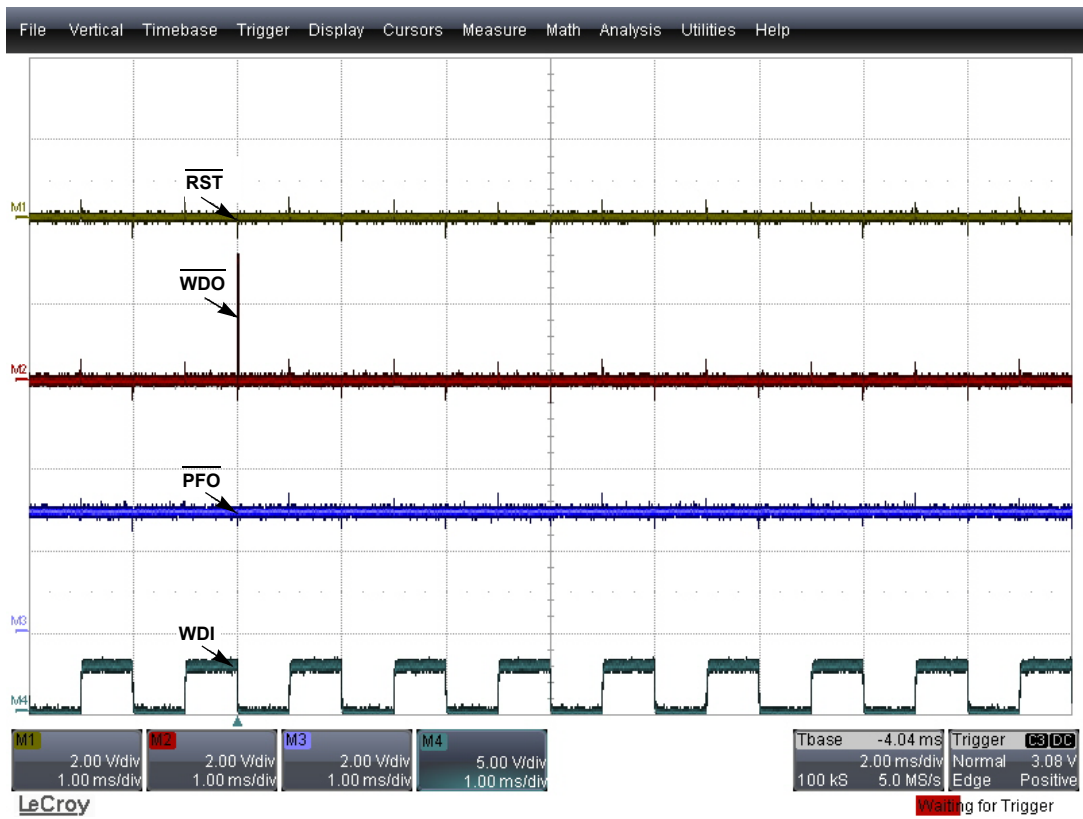


FIGURE 8. TRANSIENT ON \overline{WDO} ($V_{DD} = \overline{MR} = \overline{PFI} = 2.9V$, WDI IS TOGGLING 0 TO V_{DD} AT 1kHz)

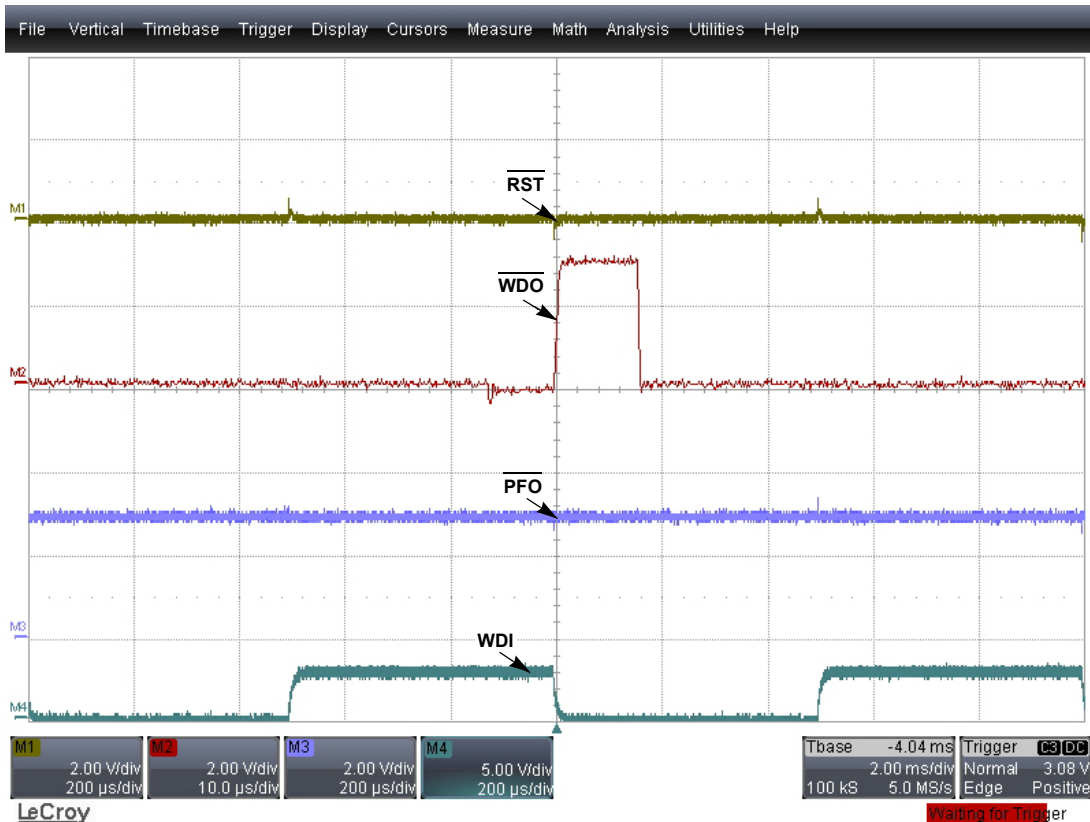


FIGURE 9. SAME \overline{WDO} TRANSIENT AS Figure 8 WITH 10µs PER DIVISION TIME SCALE

ISL706A $\overline{\text{PFO}}$ Results

The PFI/ $\overline{\text{PFO}}$ function is identical to that of the ISL705A, except the negative input of the comparator is tied to an on-chip 0.6V voltage reference. The specification allows a $\pm 24\text{mV}$ offset over temperature and radiation. Hence input voltages below 0.576V set $\overline{\text{PFO}}$ low and voltages above 0.624V set $\overline{\text{PFO}}$ high. [Table 8](#) lists $\overline{\text{PFO}}$ transients as a function of PFI input voltage for Au ions. One transient was seen when driving PFI to the minimum specs of 0.576V. By increasing the comparator overdrive, the transient cross section was eliminated. Again, even at minimum overdrive conditions (input 0.576V) the transient cross section is so small that the occurrence will be hundreds to thousands of years apart. [Figure 10](#) shows the scope trace for the $\overline{\text{PFO}}$ transient with PFI at 0.576V. Note the LHL transient is 6 μs long, adding an external

low-pass filter would reduce the glitch. This would add delay in the system that the designer would need to evaluate. When PFI was above the threshold voltage of 0.624V no HLH transitions were observed. This indicates that when an auxiliary voltage is within regulation (above the threshold) the PFI comparator would not indicate otherwise.

Additional testing at lower LET levels was done on the $\overline{\text{PFO}}$ output in the conditions that experienced SETs, e.g., $V_{\text{DD}} = 3.15\text{V}$ with PFI = 0.576V. [Table 9](#) shows the cross section versus the different LET levels tested. Note that the fluence was increased as the LET levels were lowered. The data also shows that for $\text{LET} < 43\text{MeV}\cdot\text{cm}^2/\text{mg}$ there are no SETs on $\overline{\text{PFO}}$ in that test condition.

TABLE 8. $\overline{\text{PFO}}$ TRANSIENTS vs PFI INPUT VOLTAGE ($\overline{\text{MR}} = V_{\text{DD}}$ unless noted otherwise)

LET (MeV/mg/cm ²)	PFI VOLTAGE (V)	V _{DD} (V)	EXPECTED $\overline{\text{PFO}}$ STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	0.57	3	0	0	N/A	8×10^6	
	0.576	3.15	0	1	N/A	8×10^6	1.3×10^{-7}
	0.625	3.3	1	N/A	0	8×10^6	
	0.75	3.6	1	N/A	0	8×10^6	

TABLE 9. $\overline{\text{PFO}}$ TRANSIENTS vs LET for PFI = 0.576V ($\overline{\text{MR}} = V_{\text{DD}}$ unless noted otherwise)

LET (MeV/mg/cm ²)	PFI VOLTAGE (V)	V _{DD} (V)	EXPECTED $\overline{\text{PFO}}$ STATE	LHL TRANSITIONS	HLH TRANSITIONS	FLUENCE (/cm ²)	CROSS SECTION (cm ²)
86.4	0.576	3.15	0	1	N/A	8×10^6	1.3×10^{-7}
43	0.576	3.15	0	0	N/A	1.6×10^7	
28	0.576	3.15	0	0	N/A	4×10^7	
8.5	0.576	3.15	0	0	N/A	8×10^7	

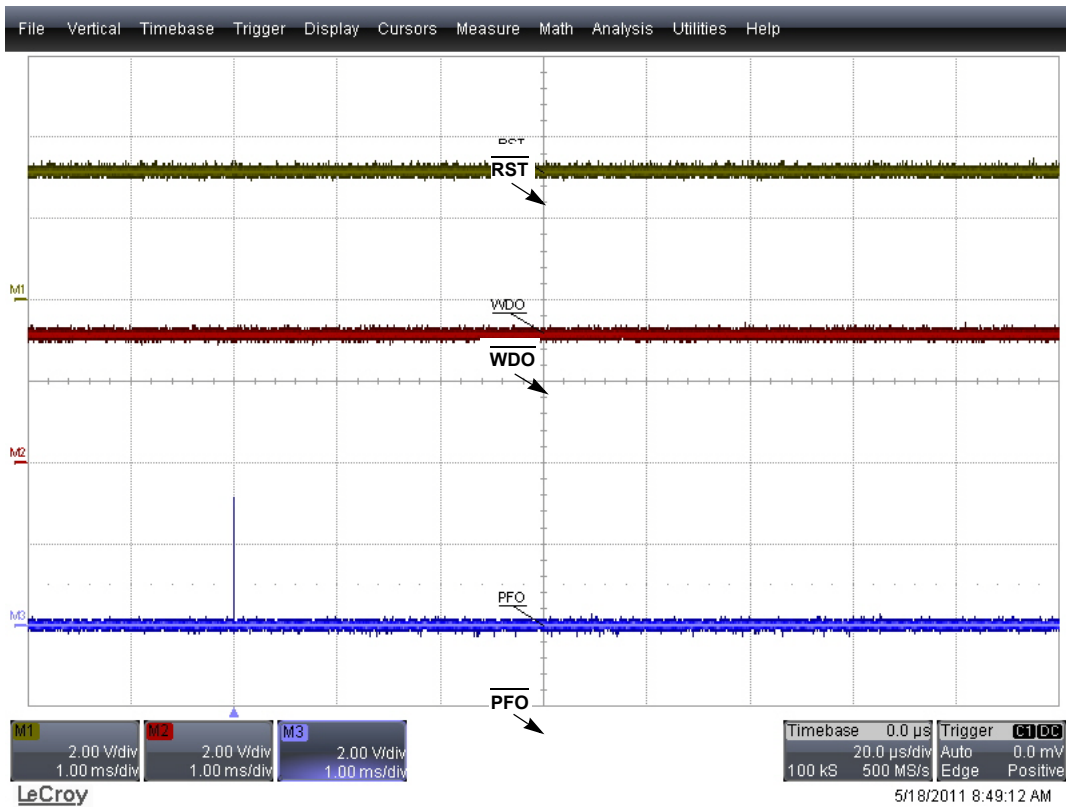


FIGURE 10. TRANSIENT ON PFO ($V_{DD} = \overline{MR} = 3.15V$, $PFI = 0.576V$, \overline{WDO} IS FLOATING)

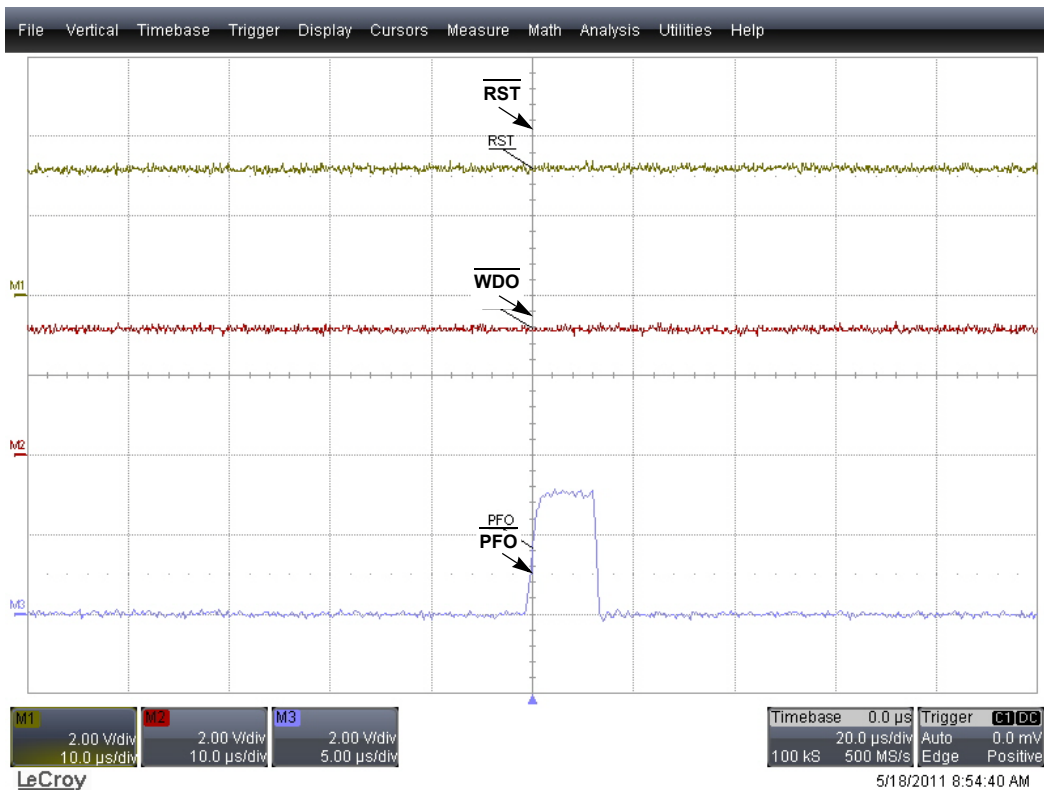


FIGURE 11. SAME PFO TRANSIENT AS [Figure 10](#) WITH 10μs PER DIVISION TIME SCALE

ISL706A Summary

As with the ISL705A, the ISL706A has no Reset HLH or LHL single-event transients at an LET of 86.4MeV/mg/cm^2 . The $\overline{\text{WDO}}$ output did have 25 times more transients compared to the ISL705A when used as a low line indicator (WDI floating). These transients did occur only when V_{DD} was below the reset threshold. The increase in the number of transients seen is primarily due to tighter thresholds in the ISL706x family of circuits. Other functions have demonstrated cross sections so small to not occur for hundreds to thousands of years. The $\overline{\text{PFO}}$ output experienced only one transient during SEE testing, compared to the ISL705A testing, which had 25 transients on $\overline{\text{PFO}}$. The main contribution for the reduction in transients is the internal SEE mitigation filters. Both the ISL705A and ISL706A have these filters; however, in the ISL706A with the lower bias levels, there is less drive capability in the $\overline{\text{PFO}}$ comparator. As a result, the ISL706A benefits by experiencing less and shorter $\overline{\text{PFO}}$ transients at minimal overdrive.

Conclusion

This Application Note has presented the results of single-event effects testing of the ISL705A and ISL706A supervisory circuits. The integrated circuit has no SEL or SEB with a supply voltage of up to 6.5V at an LET of 86.4MeV/mg/cm^2 . The initial SEE characterization of the ISL705A and ISL706A demonstrated that this device does not create/cause false system shutdowns at 86MeV. Furthermore, testing shows that the part will indicate a “system good” signal when it shouldn’t, but the user needs to keep in mind this is in a window of when the general “system” is not in normal operation mode anyway. The additional testing at lower LETs revealed less events and demonstrates lower cross-sections; which may be useful from a cross section analysis. But with a device like this, understanding the way the part will be used in a specific application vs the SEE performance is critical.

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